HIGH SPEED 4K x 8 CMOS PROM/RPROM

FOR MAINTENANCE PURPOSES ONLY! NOT TO BE USED FOR NEW DESIGNS. SEE WS57C43C FOR NEW VERSION!

KEY FEATURES

- **Ultra-Fast Access Time**
  - 35 ns
- **Low Power Consumption**
- **Fast Programming**
- **Pin Compatible with Am27S43 and N82S321 Bipolar PROMs**
- **Immune to Latch-Up**
  - Up to 200 mA
- **Available in 300 Mil DIP**

GENERAL DESCRIPTION

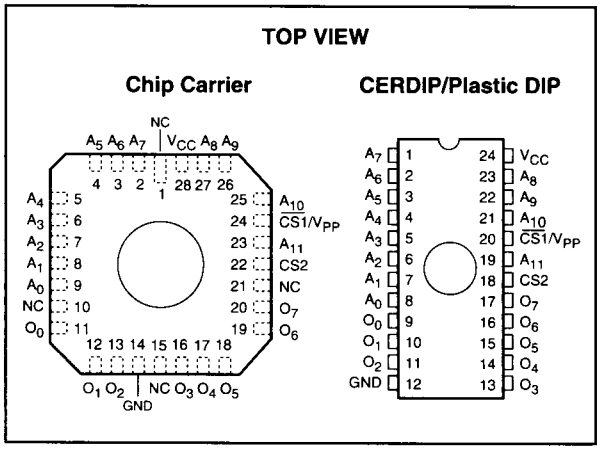
The WS57C43B is an extremely High Performance 32K UV Erasable Electrically Re-Programmable Read Only Memory (RPROM). It is manufactured in an advanced CMOS technology which enables it to operate at Bipolar PROM speeds while consuming only 25% of the power required by its Bipolar counterparts. A further advantage of the WS57C43B over Bipolar PROM devices is the fact that it utilizes a proven EPROM technology. This enables the entire memory array to be tested for switching characteristics and functionality after assembly. Unlike devices which cannot be erased, every WS57C43B in a windowed package is 100% tested with worst case test patterns both before and after assembly.

The WS57C43B is configured in the standard Bipolar PROM pinout which provides an easy upgrade path for systems which are currently using Bipolar PROMs.

MODE SELECTION

MODE \ PINS	$\overline{CS1}/V_{PP}$	CS2	V_{CC}	OUTPUTS
Read	V_{IL}	V_{IH}	V_{CC}	D_{OUT}
Output Disable	V_{IH}	X	V_{CC}	High Z
Output Disable	X	V_{IL}	V_{CC}	High Z
Program	V_{PP}	X	V_{CC}	D_{IN}
Program Verify	V_{IL}	V_{IH}	V_{CC}	D_{OUT}

PIN CONFIGURATION



PRODUCT SELECTION GUIDE

PARAMETER	WS57C43B-35	WS57C43B-45	WS57C43B-55	WS57C43B-70
Address Access Time (Max)	35 ns	45 ns	55 ns	70 ns
CS to Output Valid Time (Max)	20 ns	25 ns	25 ns	25 ns

ABSOLUTE MAXIMUM RATINGS*

Storage Temperature.....–65° to + 150°C

Voltage on any Pin with Respect to Ground .....–0.6V to +7V

V_{PP} with Respect to Ground.....–0.6V to + 14V

ESD Protection.....>2000V

*NOTICE:
Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.

OPERATING RANGE

RANGE	TEMPERATURE	V_{CC}
Commercial	0°C to +70°C	+5V ± 5%
Industrial	–40°C to +85°C	+5V ± 10%
Military	–55°C to +125°C	+5V ± 10%

DC READ CHARACTERISTICS Over Operating Range. (See Above)

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	MAX	UNITS
V_{IL}	Input Low Voltage	(Note 4)		–0.1	0.8	V
V_{IH}	Input High Voltage	(Note 4)		2.0	V_{CC} + 0.3	V
V_{OL}	Output Low Voltage	I_{OL} = 16 mA			0.4	V
V_{OH}	Output High Voltage	I_{OH} = –4 mA		2.4		V
I_{CC1}	V_{CC} Active Current (CMOS)	(Notes 1 and 3) Outputs Not Loaded	Comm'l		30	mA
			Industrial		35	mA
			Military		35	mA
I_{CC2}	V_{CC} Active Current (TTL)	(Notes 2 and 3) Outputs Not Loaded	Comm'l		40	mA
			Industrial		40	mA
			Military		40	mA
I_{LI}	Input Leakage Current	V_{IN} = 5.5V or Gnd		–10	10	µA
I_{LO}	Output Leakage Current	V_{OUT} = 5.5 V or Gnd		–10	10	µA

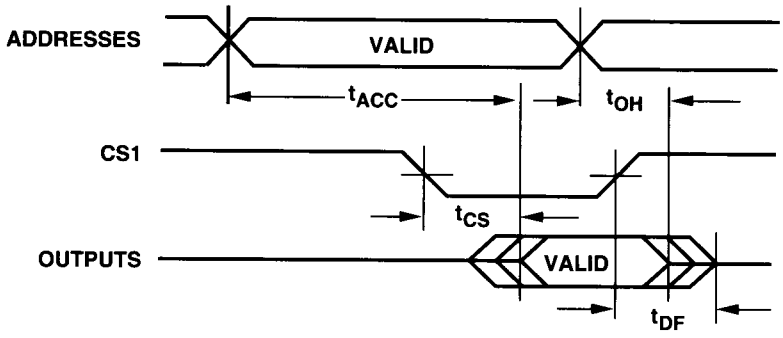
NOTES:
1. CMOS inputs: GND ± 0.3V or V_{CC} ± 0.3V.
2. TTL inputs: $V_{IL} \leq 0.8V$, $V_{IH} \geq 2.0V$.
3. Add 3 mA/MHz for A.C. power component.
4. These are absolute voltages with respect to device ground pin and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.

AC READ CHARACTERISTICS Over Operating Range. (See Above)

PARAMETER	SYMBOL	57C43B-35		57C43B-45		57C43B-55		57C43B-70		UNITS
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
Address to Output Delay	t_{ACC}		35		45		55		70	ns
$\overline{CS1}$ to Output Delay	t_{CS}		20		25		25		25	
Output Disable to Output Float*	t_{DF}		25		25		25		25	
Address to Output Hold	t_{OH}	0		0		0		0		

*Sampled, Not 100% Tested.

AC READ TIMING DIAGRAM

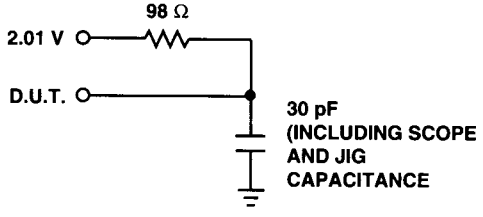


CAPACITANCE[5] T_A = 25°C, f = 1 MHz

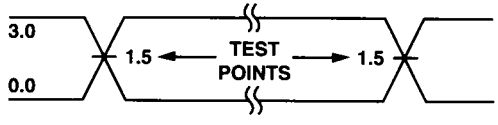
SYMBOL	PARAMETER	CONDITIONS	TYP[6]	MAX	UNITS
C_{IN}	Input Capacitance	V_{IN} = 0V	4	6	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	8	12	pF
C_{VPP}	V_{PP} Capacitance	V_{PP} = 0 V	18	25	pF

NOTES: 5. This parameter is only sampled and is not 100% tested.
6.Typical values are for T_A = 25°C and nominal supply voltages.

TEST LOAD (High Impedance Test Systems)



A.C. TESTING INPUT/OUTPUT WAVEFORM



A.C. testing inputs are driven at 3.0 V for a logic "1" and 0.0 V for a logic "0." Timing measurements are made at 1.5 V for input and output transitions in both directions.

NOTE: 7. Provide adequate decoupling capacitance as close as possible to this device to achieve the published A.C. and D.C. parameters. A 1.0 microfarad capacitor in parallel with a 0.1 microfarad capacitor connected between V_{CC} and ground is recommended. Inadequate decoupling may result in access time degradation or other transient performance failures.

PROGRAMMING INFORMATION

DC CHARACTERISTICS (T_A = 25 ± 5°C, V_{CC} = 5.6 V ± 0.25 V, V_{PP} = 13.5 ± 0.5 V)

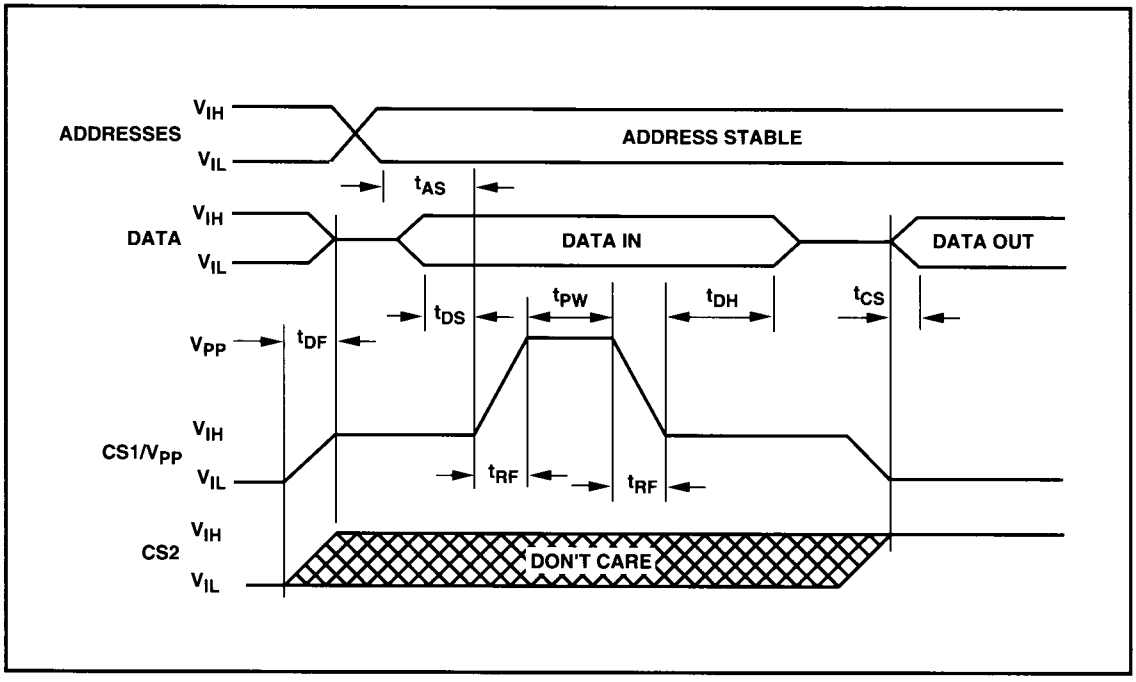
SYMBOLS	PARAMETER	MIN	MAX	UNITS
I_{LI}	Input Leakage Current (V_{IN} = V_{CC} or Gnd)	–10	10	µA
I_{PP}	V_{PP} Supply Current During Programming Pulse		60	mA
I_{CC}	V_{CC} Supply Current (Notes 2 and 3)		30	mA
V_{OL}	Output Low Voltage During Verify (I_{OL} = 16 mA)		0.45	V
V_{OH}	Output High Voltage During Verify (I_{OH} = –4 mA)	2.4		V

NOTES: 8. V_{PP} must not be greater than 14 volts including overshoot.

AC CHARACTERISTICS (T_A = 25 ± 5°C, V_{CC} = 5.6 V ± 0.25 V, V_{PP} = 13.5 ± 0.5 V)

SYMBOLS	PARAMETER	MIN	TYP	MAX	UNITS
t_{AS}	Address Setup Time	2			µs
t_{DF}	Chip Disable Setup Time			30	ns
t_{DS}	Data Setup Time	2			µs
t_{PW}	Program Pulse Width	1	3	10	ms
t_{DH}	Data Hold Time	2			µs
t_{CS}	Chip Select Delay			30	ns
t_{RF}	V_{PP} Rise and Fall Time	1			µs

PROGRAMMING WAVEFORM



ORDERING INFORMATION

PART NUMBER	SPEED (ns)	PACKAGE TYPE	PACKAGE DRAWING	OPERATING TEMPERATURE RANGE	WSI MANUFACTURING PROCEDURE
WS57C43B-35D	35	24 Pin CERDIP, 0.6"	D1	Comm'l	Standard
WS57C43B-35J	35	28 Pin PLDCC	J3	Comm'l	Standard
WS57C43B-35T	35	24 Pin CERDIP, 0.3"	T1	Comm'l	Standard
WS57C43B-45CM	45	28 Pad CLLCC , 0.3"	C1	Military	Standard
WS57C43B-45CMB	45	28 Pad CLLCC , 0.3"	C1	Military	MIL-STD-883C
WS57C43B-45D	45	24 Pin CERDIP, 0.6"	D1	Comm'l	Standard
WS57C43B-45J	45	28 Pin PLDCC	J3	Comm'l	Standard
WS57C43B-45S	45	24 Pin Plastic DIP, 0.3"	S1	Comm'l	Standard
WS57C43B-45T	45	24 Pin CERDIP, 0.3"	T1	Comm'l	Standard
WS57C43B-45TI	45	24 Pin CERDIP, 0.3"	T1	Industrial	Standard
WS57C43B-45TMB	45	24 Pin CERDIP, 0.3"	T1	Military	MIL-STD-883C
WS57C43B-55D	55	24 Pin CERDIP, 0.6"	D1	Comm'l	Standard
WS57C43B-55T	55	24 Pin CERDIP, 0.3"	T1	Comm'l	Standard
WS57C43B-55TMB	55	24 Pin CERDIP, 0.3"	T1	Military	MIL-STD-883C
WS57C43B-70D	70	24 Pin CERDIP, 0.6"	D1	Comm'l	Standard
WS57C43B-70TMB	70	24 Pin CERDIP, 0.3"	T1	Military	MIL-STD-883C

NOTE: The actual part marking will not include the initials "WS."

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PROGRAMMING/ALGORITHMS/ERASURE/PROGRAMMERS

REFER TO PAGE 6-1

The WS57C43B is programmed using Algorithm A shown on page 6-3.

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